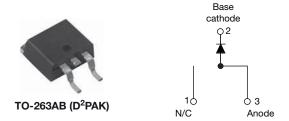


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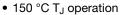
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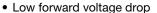
High Performance Schottky Rectifier, 20 A



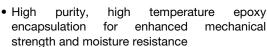
PRODUCT SUMMARY	
Package	TO-263AB (D ² PAK)
I _{F(AV)}	20 A
V_{R}	35 V, 40 V, 45 V
V _F at I _F	0.51 V
I _{RM}	105 mA at 125 °C
T _J max.	150 °C
Diode variation	Single die
E _{AS}	27 mJ

FEATURES











- Guard ring for enhanced ruggedness and long term reliability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

The VS-20TQ... Schottky rectifier series has been optimized for very low forward voltage drop, with moderate leakage. The proprietary barrier technology allows for reliable operation up to 150 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS						
SYMBOL	CHARACTERISTICS	VALUES	UNITS			
I _{F(AV)}	Rectangular waveform	20	А			
V_{RRM}	Range	35 to 45	V			
I _{FSM}	t _p = 5 μs sine	1800	А			
V _F	20 A _{pk} , T _J = 125 °C	0.51	V			
T_J	Range	-55 to +150	°C			

VOLTAGE RATINGS					
PARAMETER	SYMBOL	VS-20TQ035SPbF	VS-20TQ040SPbF	VS-20TQ045SPbF	UNITS
Maximum DC reverse voltage	V_R	35	40	45	W
Maximum working peak reverse voltage	V_{RWM}	33	40	45	v

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	YMBOL TEST CONDITIONS VALUES UNI			
Maximum average forward current, see fig. 5	I _{F(AV)}	50 % duty cycle at T _C = 116 °C	C, rectangular waveform	20	
Maximum peak one cycle non-repetitive		5 μs sine or 3 μs rect. pulse	Following any rated load	1800	Α
surge current, see fig. 7	IFSM	10 ms sine or 6 ms rect. pulse	condition and with rated V _{RRM} applied	400	
Non-repetitive avalanche energy	E _{AS}	$T_J = 25 ^{\circ}\text{C}, I_{AS} = 4 \text{A}, L = 3.40 \text{M}$	mH	27	mJ
Repetitive avalanche current	I _{AR}	Current decaying linearly to zero Frequency limited by T_J maxim		4	Α



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ELECTRICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST COND	TEST CONDITIONS			
		20 A	T _{.1} = 25 °C	0.57		
Maximum forward voltage drop See fig. 1	V _{FM} ⁽¹⁾	40 A	11 = 23 0	0.73	V	
	V FM (*)	20 A	T _{.1} = 125 °C	0.51		
		40 A	1J = 125 C	0.67		
Maximum reverse leakage current	1 (1)	T _J = 25 °C	V _R = Rated V _R	2.7	mA	
See fig. 2	I _{RM} ⁽¹⁾	T _J = 125 °C	v _R = nateu v _R	105	IIIA	
Maximum junction capacitance	C _T	V _R = 5 V _{DC} (test signal range	100 kHz to 1 MHz), 25 °C	1400	pF	
Typical series inductance	LS	Measured lead to lead 5 mm	from package body	8.0	nH	
Maximum voltage rate of change	dV/dt	Rated V _R		10 000	V/µs	

Note

 $^{^{(1)}\,}$ Pulse width < 300 µs, duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS					
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction and storage temperature range		T _J , T _{Stg}		-55 to +150	°C
Maximum thermal resistance, junction to case		R _{thJC}	DC operation See fig. 4	1.50	°C/W
Typical thermal resistance, case to heatsink		R _{thCS}	Mounting surface, smooth and greased	0.50	C/VV
Approximate weight				2	g
Approximate weight				0.07	OZ.
Manusting toward	minimum			6 (5)	kgf · cm
Mounting torque	maximum			12 (10)	(lbf · in)
Marking device			Case style TO-263AB (D ² PAK)	20TQ	045S

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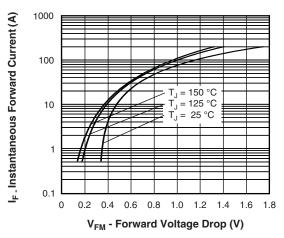


Fig. 1 - Maximum Forward Voltage Drop Characteristics

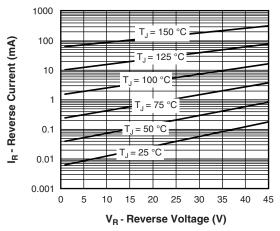


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

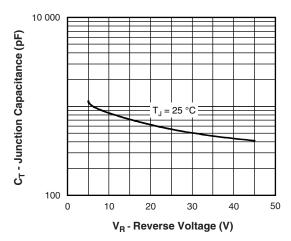


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

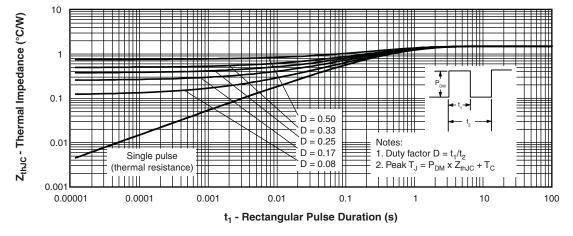


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

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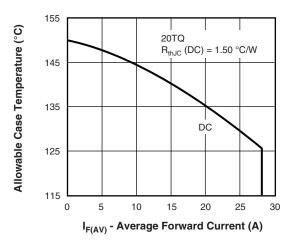


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

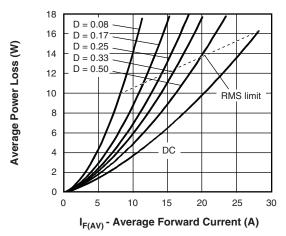


Fig. 6 - Forward Power Loss Characteristics

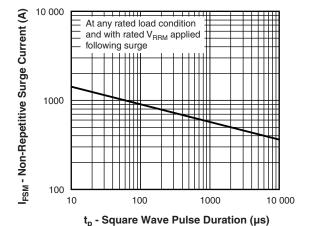


Fig. 7 - Maximum Non-Repetitive Surge Current

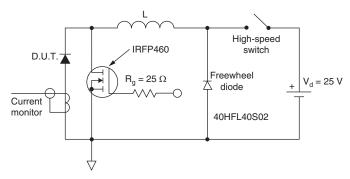
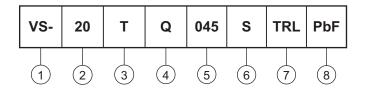


Fig. 8 - Unclamped Inductive Test Circuit

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ORDERING INFORMATION TABLE

Device code



Vishay Semiconductors product

Current rating (20 A)

3 Package: T = TO-220

Schottky "Q" series

035 = 35 V 040 = 40 V Voltage ratings -045 = 45 V

 $S = D^2PAK$

• None = tube (50 pieces)

• TRL = tape and reel (left oriented)

• TRR = tape and reel (right oriented)

8 PbF = lead (Pb)-free

ORDERING INFORMAT	ION (Example)		
PREFERRED P/N	QUANTITY PER REEL	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION
VS-20TQ035SPBF	50	1000	Antistatic plastic tubes
VS-20TQ035STRRPBF	800	800	13" diameter plastic tape and reel
VS-20TQ035STRLPBF	800 800 13" diameter plastic		13" diameter plastic tape and reel
VS-20TQ035-1PBF	50	1000	Antistatic plastic tubes
VS-20TQ040SPBF	50	1000	Antistatic plastic tubes
VS-20TQ040STRRPBF	800	800	13" diameter plastic tape and reel
VS-20TQ040STRLPBF	800	800	13" diameter plastic tape and reel
VS-20TQ040-1PBF	50	1000	Antistatic plastic tubes
VS-20TQ045SPBF	50	1000	Antistatic plastic tubes
VS-20TQ045STRRPBF	800	800	13" diameter plastic tape and reel
VS-20TQ045STRLPBF	800	800	13" diameter plastic tape and reel
VS-20TQ045-1PBF	50	1000	Antistatic plastic tubes

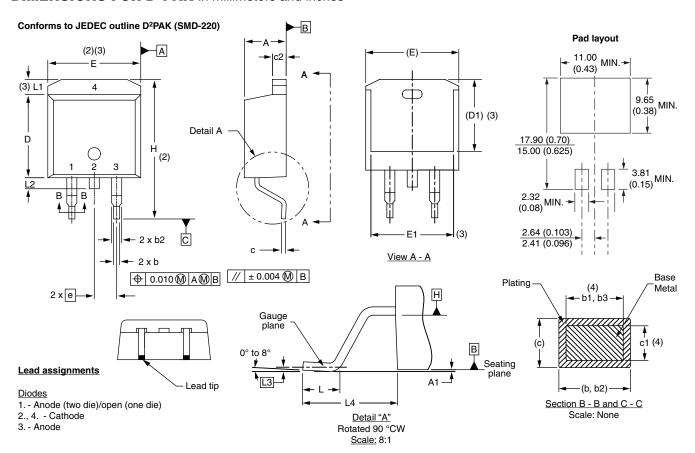
LINKS TO RELATED DOCUMENTS			
Dimensions	TO-263AB (D ² PAK)	www.vishay.com/doc?95046	
Dimensions	TO-262AA	www.vishay.com/doc?95014	
Part marking information		www.vishay.com/doc?95008	
Packaging information		www.vishay.com/doc?95032	



Vishay High Power Products

D²PAK, TO-262

DIMENSIONS FOR D²PAK in millimeters and inches



	MILLIM	IETERS	INC	NOTEO	
SYMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190	
A1	0.00	0.254	0.000	0.010	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
С	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2

SYMBOL	MILLIM	ETERS	INC	HES	NOTES
STIVIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
е	2.54 BSC		0.100 BSC		
Н	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	-	1.65	-	0.066	3
L2	1.27	1.78	0.050	0.070	
L3	0.25 BSC		0.010	BSC	
L4	4.78	5.28	0.188	0.208	

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- $^{(3)}\,$ Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch

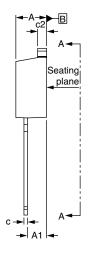
(7) Outline conforms to JEDEC outline TO-263AB

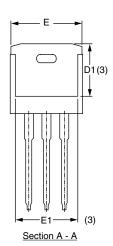
Vishay High Power Products

D²PAK, TO-262



DIMENSIONS FOR TO-262 in millimeters and inches





⊕ 0.010**⋒**|A**⋒**|B

Lead assignments

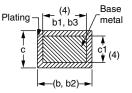


<u>Diodes</u>

-3 x b2 --3 x b

> 1. - Anode (two die)/open (one die) 2., 4. - Cathode

3. - Anode



Section B - B and C - C Scale: None

CVMDOL	MILLIN	MILLIMETERS		INCHES		
SYMBOL	MIN.	MAX.	MIN.	MAX.	NOTES	
Α	4.06	4.83	0.160	0.190		
A1	2.03	3.02	0.080	0.119		
b	0.51	0.99	0.020	0.039		
b1	0.51	0.89	0.020	0.035	4	
b2	1.14	1.78	0.045	0.070		
b3	1.14	1.73	0.045	0.068	4	
С	0.38	0.74	0.015	0.029		
c1	0.38	0.58	0.015	0.023	4	
c2	1.14	1.65	0.045	0.065		
D	8.51	9.65	0.335	0.380	2	
D1	6.86	8.00	0.270	0.315	3	
Е	9.65	10.67	0.380	0.420	2, 3	
E1	7.90	8.80	0.311	0.346	3	
е	2.54 BSC		0.10	0 BSC		
L	13.46	14.10	0.530	0.555		
L1	-	1.65	-	0.065	3	
L2	3.56	3.71	0.140	0.146		

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Controlling dimension: inches

(6) Outline conform to JEDEC TO-262 except A1 (maximum), b (minimum) and D1 (minimum) where dimensions derived the actual package outline



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Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

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